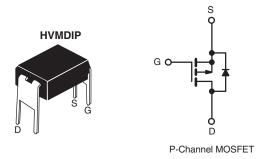


Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 10	- 100			
R _{DS(on)} (Ω)	V _{GS} = - 10 V	0.60			
Q _g (Max.) (nC)	18	18			
Q _{gs} (nC)	3.0	3.0			
Q _{gd} (nC)	9.0	9.0			
Configuration	Sing	Single			



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- P-Channel
- 175 °C Operating Temperature
- · Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION				
Package	HVMDIP			
Lead (Pb)-free	IRFD9120PbF			
Lead (Fb)-liee	SiHFD9120-E3			
SnPb	IRFD9120			
OIII D	SiHFD9120			

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V_{DS}	- 100	V	
Gate-Source Voltage	V_{GS}	± 20	- V		
Continuous Drain Current	V_{GS} at - 10 V $T_A = 25 ^{\circ}\text{C}$ $T_A = 100 ^{\circ}\text{C}$	- I _D -	- 1.0	А	
Continuous Drain Current	$T_A = 100 ^{\circ}$ C		- 0.70		
Pulsed Drain Current ^a	I _{DM}	- 8.0			
Linear Derating Factor		0.0083	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	140	mJ		
Repetitive Avalanche Current ^a	I _{AR}	- 1.0	Α		
Repetitive Avalanche Energy ^a	E _{AR}	0.13	mJ		
Maximum Power Dissipation	T _A = 25 °C	P _D	1.3	W	
Peak Diode Recovery dV/dt ^c	dV/dt	- 5.5	V/ns		
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 52 mH, R_g = 25 Ω , I_{AS} = 2.0 A (see fig. 12).
- c. $I_{SD} \le -6.8 \text{ A}$, $dI/dt \le 110 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \,^{\circ}\text{C}$.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFD9120, SiHFD9120

Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R_{thJA}	-	120	°C/W	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	: 0 V, I _D = - 250 μA	- 100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = - 1 mA	-	- 0.10	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		- 100 V, V _{GS} = 0 V	-	-	- 100	μA
0			/, V _{GS} = 0 V, T _J = 150 °C	-	-	- 500	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	•	ı	-	0.60	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = -$	50 V, I _D = - 0.60 A ^b	0.71	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 \text{ V}$	-	390		
Output Capacitance	C_{oss}		V _{DS} = - 25 V	ı	170	-	pF
Reverse Transfer Capacitance	C_{rss}	t = 1.	0 MHz, see fig. 5	ı	45	-	
Total Gate Charge	Q_g			-	-	18	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$V_{GS} = -10 \text{ V}$ $I_D = -6.8 \text{ A}, V_{DS} = -80 \text{ V}$ see fig. 6 and 13 ^b	-	-	3.0	nC
Gate-Drain Charge	Q _{gd}	1		-	-	9.0	
Turn-On Delay Time	t _{d(on)}	V_{DD} = - 50 V, I_{D} = - 6.8 A R_{q} = 18 Ω, R_{D} = 7.1 Ω, see fig. 10 ^b		-	9.6	-	- ns
Rise Time	t _r			-	29	-	
Turn-Off Delay Time	t _{d(off)}			1	21	-	
Fall Time	t _f		_		25	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	-11
Internal Source Inductance	L _S			-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 1.0	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 8.0	^
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = - 1.0 A, V _{GS} = 0 V ^b		-	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T 05.00 :	0.0.4	-	98	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -6.8 \text{A}, \text{dI/dt} = 100 \text{A/}\mu\text{s}^b$		-	0.33	0.66	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

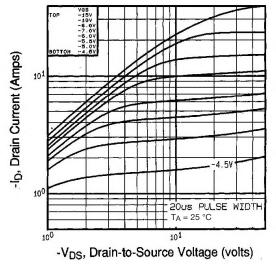


Fig. 1 - Typical Output Characteristics, T_A = 25 °C

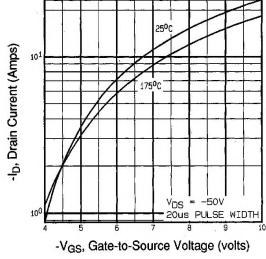


Fig. 3 - Typical Transfer Characteristics

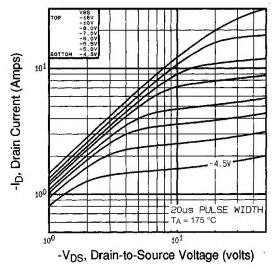


Fig. 2 - Typical Output Characteristics, T_A = 175 °C

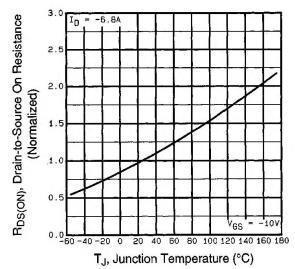


Fig. 4 - Normalized On-Resistance vs. Temperature



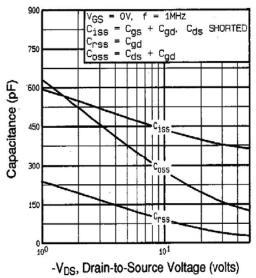


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

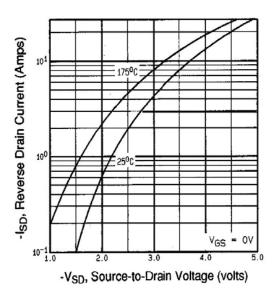


Fig. 7 - Typical Source-Drain Diode Forward Voltage

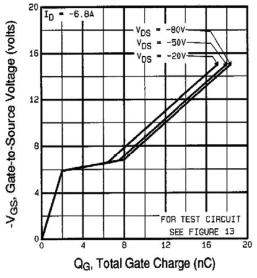


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

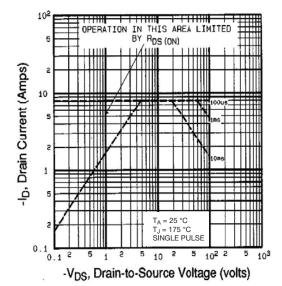


Fig. 8 - Maximum Safe Operating Area





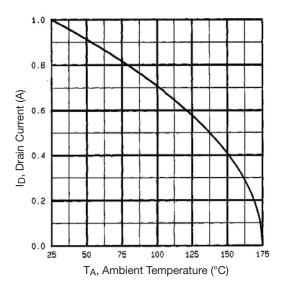


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

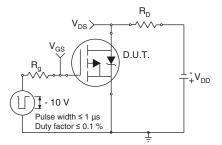


Fig. 10a - Switching Time Test Circuit

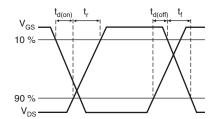


Fig. 10b - Switching Time Waveforms

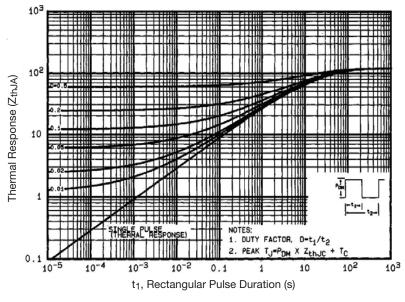


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



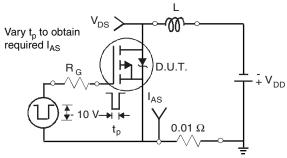


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

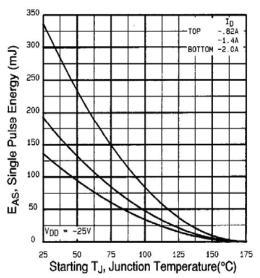


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

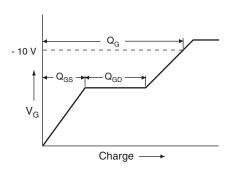


Fig. 13a - Basic Gate Charge Waveform

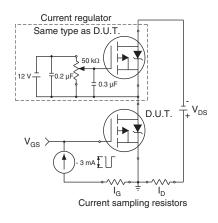
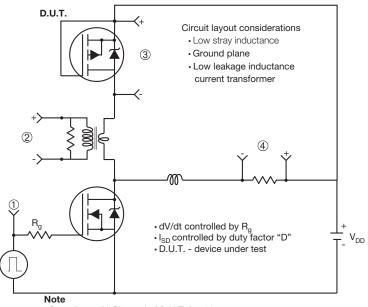


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

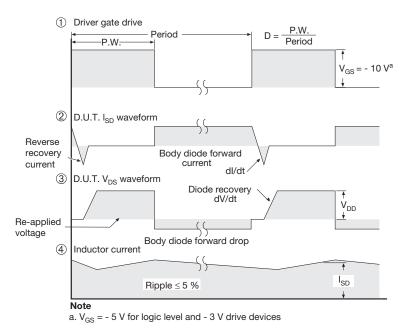
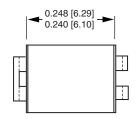
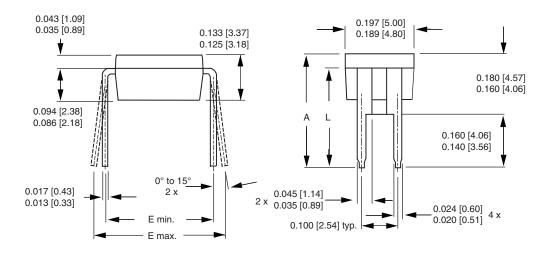


Fig. 14 - For P-Channel

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HVM DIP (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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